

30V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	Max R _{DS(on)}	Max I _D @ T _A = 25°C
	1Ω @ V _{GS} = -4.5V	-0.67A
-30V	1.5Ω @ V _{GS} = -2.5V	-0.54A
	2Ω @ V _{GS} = -1.8V	-0.47A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

• Load Switch in portable electronics

Features and Benefits

- Low Gate Threshold Voltage
- Fast Switching Speed
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- ESD Protected Gate 2KV
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

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- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin
- · Weight: 0.08 grams (approximate)

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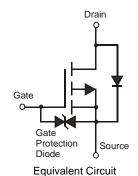




SOT23

Top View Top View Internal Schematic

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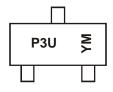
Ordering Information (Note 3)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMP31D0U-7	P3U	7	8	3,000

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free.

- 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



P3U = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Y		Z		Α	[3	С		D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @TA = 25°C unless otherwise specified

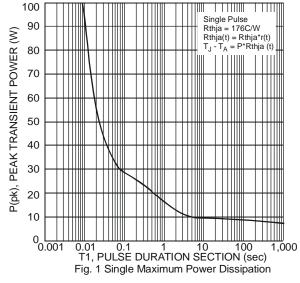
Cha	racteristic		Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	-30	V
Gate-Source Voltage			V_{GSS}	±8	V
Continuous Drain Current	Steady State $T_A = 25$ °C (Note 5) $T_A = 85$ °C (Note 5) $T_A = 25$ °C (Note 4)		I _D	-0.67 -0.48 -0.53	А
Pulsed Drain Current (Note 6)			I _{DM}	2.5	A

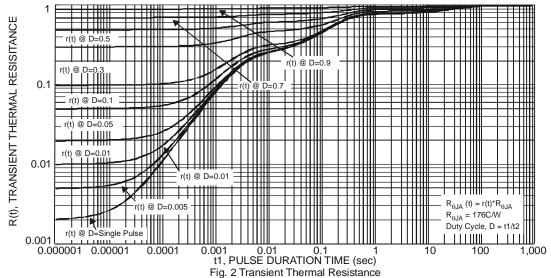
Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
(Note 4)		Б	W	
Power Dissipation	(Note 5)	PD	P _D 0.71	W
Thermal Resistance, Junction to Ambient (Note 4) (Note 5)		D	275	°C/W
		− R _{θJA}	177	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	

Notes:

- 4. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout
- 5. Device mounted on 25mm X 25mm square copper plate with FR-4 substrate PC board, 2oz copper
- 6. Device mounted on minimum recommended pad layout test board, 10μs pulse duty cycle = 1%.







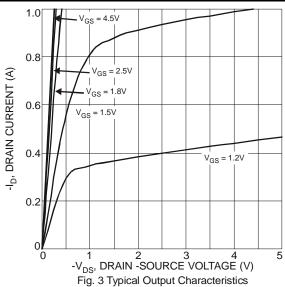


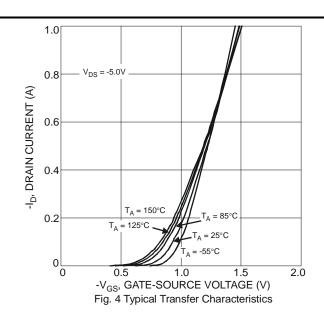
Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	1	-	-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	1	-	±3	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	-0.5	-	-1.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
				1		$V_{GS} = -4.5V$, $I_D = -400mA$	
Static Drain-Source On-Resistance	R _{DS} (ON)	-	-	1.5	Ω	$V_{GS} = -2.5V$, $I_D = -200mA$	
				2		$V_{GS} = -1.8V, I_D = -100mA$	
Forward Transfer Admittance	Y _{fs}	50	-	-	mS	$V_{DS} = -3V, I_{D} = -300 \text{mA}$	
Diode Forward Voltage	V _{SD}	1	-	-1.2	V	$V_{GS} = 0V, I_{S} = -300mA$	
DYNAMIC CHARACTERISTICS							
Input Capacitance	C _{iss}	1	76	-	pF	V 45V V 0V	
Output Capacitance	Coss	-	9	-	pF	$V_{DS} = -15V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	-	6.43	-	pF	1 – 1:01/11/12	
Gate Resistance	Rg	1	166.9	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg		0.9	-	nC	$V_{GS} = -4.5V$, $V_{DS} = -15V$, $I_{D} = -1A$	
Total Gate Charge	Qg	-	1.5	-	nC	V 0V V 45V	
Gate-Source Charge	Q _{gs}	-	0.1	-	nC	$V_{GS} = -8V, V_{DS} = -15V,$ $V_{DS} = -14V,$	
Gate-Drain Charge	Q_{gd}	-	0.2	-	nC	ID = -1A	
Turn-On Delay Time	t _{D(on)}	-	4.98	-	ns		
Turn-On Rise Time	t _r	-	5.85	-	ns	V_{DD} = -10V, R_L = 10 Ω	
Turn-Off Delay Time	t _{D(off)}	-	35.71	-	ns	V_{GS} = -4.5 V , R_{G} = 6 Ω	
Turn-Off Fall Time	t _f	-	16.64	-	ns		

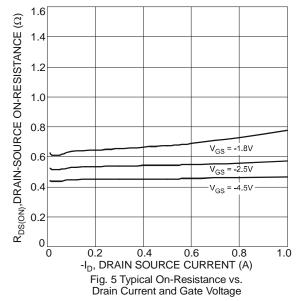
Notes: 7. Short duration pulse test used to minimize self-heating effect.

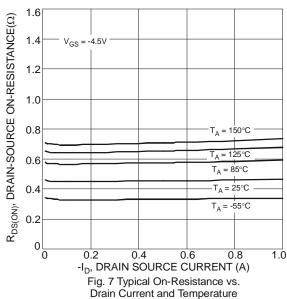
Typical Electrical Characteristics

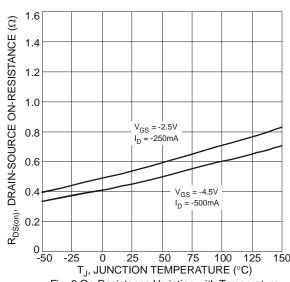


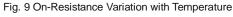


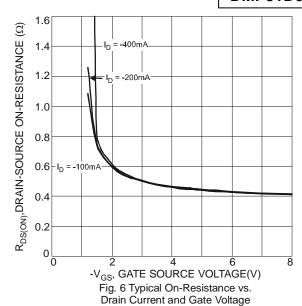


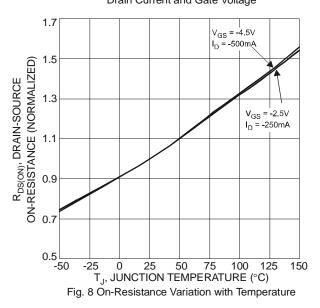












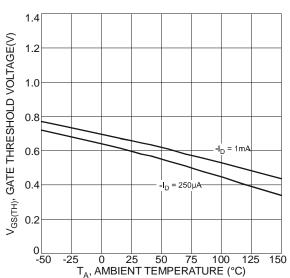
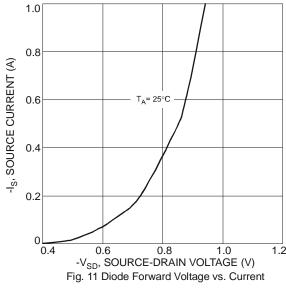


Fig. 10 Gate Threshold Variation vs. Ambient Temperature





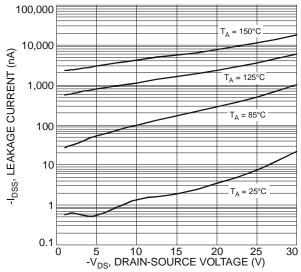
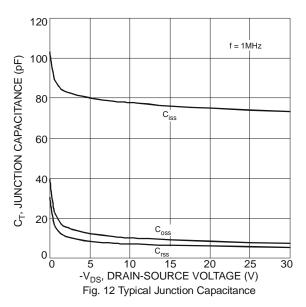
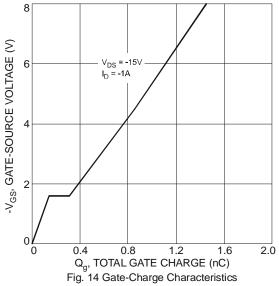


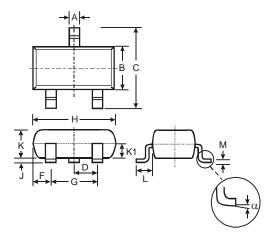
Fig. 13 Typical Drain-Source Leakage Current vs. Voltage





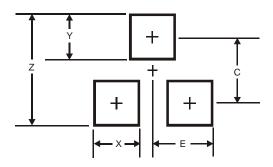


Package Outline Dimensions



SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.903	1.10	1.00			
K1	-	-	0.400			
L	0.45	0.61	0.55			
М	0.085	0.18	0.11			
α	0°	8°	-			
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35





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